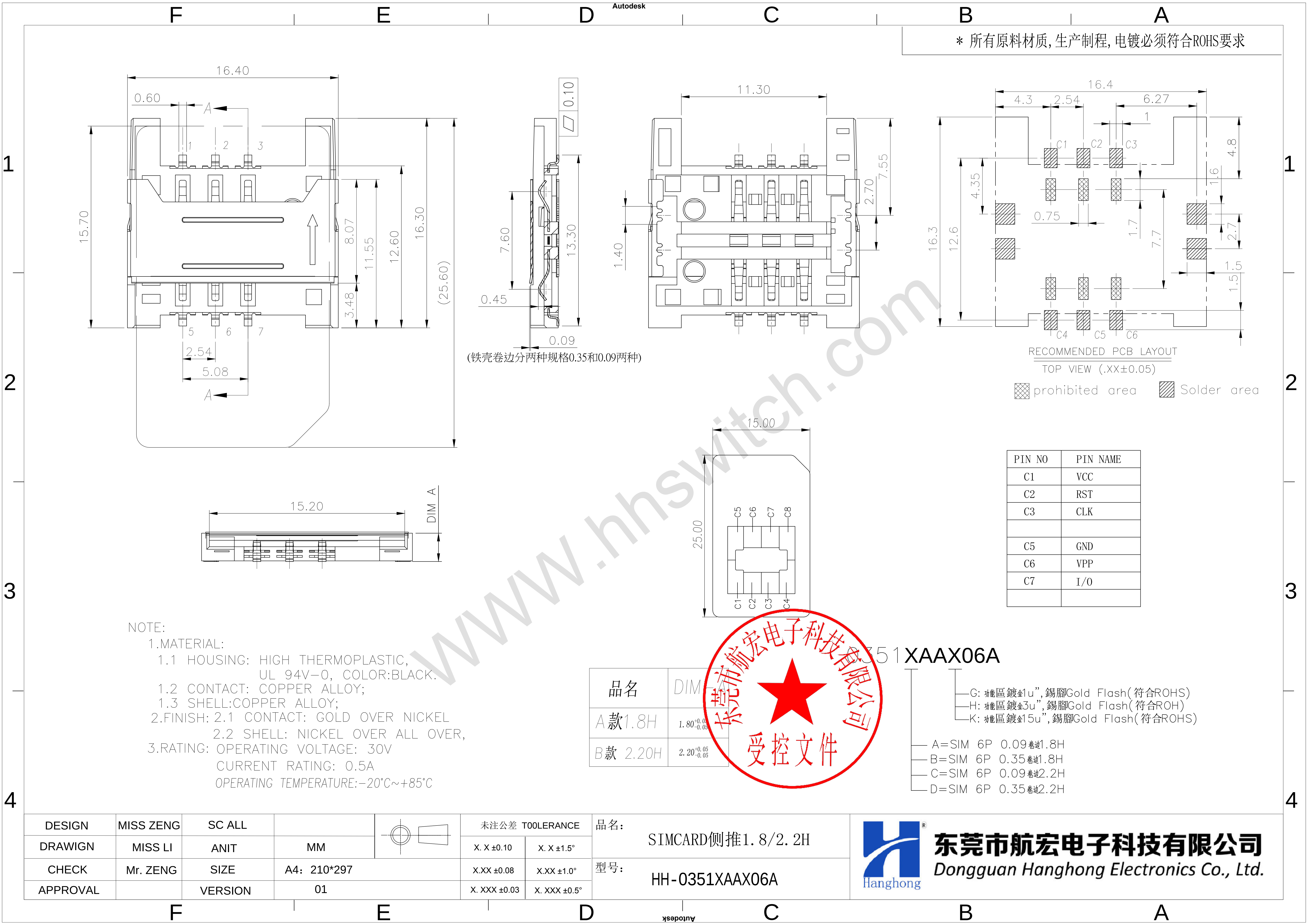




* 所有原料材质, 生产制程, 电镀必须符合ROHS要求

RECOMMENDED PCB LAYOUT
TOP VIEW (.XX±0.05)

prohibited area Solder area

PIN NO	PIN NAME
C1	VCC
C2	RST
C3	CLK
C4	
C5	GND
C6	VPP
C7	I/O
C8	

NOTE:
1.MATERIAL:
1.1 HOUSING: HIGH THERMOPLASTIC,
UL 94V-0, COLOR:BLACK.
1.2 CONTACT: COPPER ALLOY;
1.3 SHELL:COPPER ALLOY;
2.FINISH: 2.1 CONTACT: GOLD OVER NICKEL
2.2 SHELL: NICKEL OVER ALL OVER,
3.RATING: OPERATING VOLTAGE: 30V
CURRENT RATING: 0.5A
OPERATING TEMPERATURE:-20°C~+85°C

品名	DIM
A款1.8H	1.80 ^{+0.05} _{-0.05}
B款2.20H	2.20 ^{+0.05} _{-0.05}

HH-0351XAAX06A
—G: 功能區鍍金1u", 錫腳Gold Flash(符合ROHS)
—H: 功能區鍍金3u", 錫腳Gold Flash(符合ROH)
—K: 功能區鍍金15u", 錫腳Gold Flash(符合ROHS)
—A=SIM 6P 0.09卷边1.8H
—B=SIM 6P 0.35卷边1.8H
—C=SIM 6P 0.09卷边2.2H
—D=SIM 6P 0.35卷边2.2H

DESIGN	MISS ZENG	SC ALL			未注公差 T00LERANCE		品名: SIMCARD侧推1.8/2.2H
DRAWIGN	MISS LI	ANIT	MM		X.X ±0.10	X.X ±1.5°	
CHECK	Mr. ZENG	SIZE	A4: 210*297		X.XX ±0.08	X.XX ±1.0°	
APPROVAL		VERSION	01		X.XXX ±0.03	X.XXX ±0.5°	